TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

# TC7WU04F, TC7WU04FU, TC7WU04FK

## TRIPLE INVERTER

The TC7WU04 is a high speed C2MOS INVERTER fabricated with silicon gate C2MOS technology. It achives the high speed operation similar to equivalent LSTTL while maintaining the C2MOS low power

As the internal circuit is composed of single stage inverter, it can be applied for crystal oscillation. All inputs are equipped with protection circuits against static discharge or transient excess voltage.

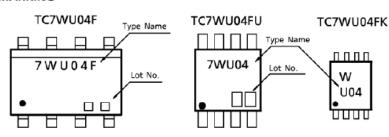
#### **FEATURES**

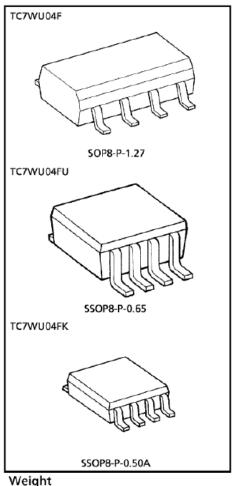
•	High Speed	 $t_{pd} = 6ns (Typ.)$	at
		Vcc -4 5V	

• Low Power Dissipation ........... 
$$I_{CC} = 1\mu A$$
 (Max.) at

Wide Operating Voltage Range ... V<sub>CC</sub> (opr) = 2~6V

#### MARKING





: 0.05g (Typ.) SOP8-P-1.27 SSOP8-P-0.65 : 0.02g (Typ.) SSOP8-P-0.50A : 0.01g (Typ.) SSOP8-P-0.65

# ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

SYMBOL	RATING	UNIT	
Vcc	-0.5~7	٧	
VIN	-0.5~V <sub>CC</sub> +0.5	٧	
VOUT	-0.5~V <sub>CC</sub> +0.5	٧	
ΊΚ	±20	mA	
ОК	± 20	mA	
IOUT	± 25	mA	
<sup>1</sup> cc	± 25	mA	
	300 (FM8, SM8)	mW	
	200 (US8)		
T <sub>stg</sub>	-65~150	ů	
ΤĹ	260	°C	
	V <sub>CC</sub> V <sub>IN</sub> V <sub>OUT</sub> I <sub>IK</sub> I <sub>OK</sub> I <sub>OUT</sub> I <sub>CC</sub>	VCC -0.5~7  VIN -0.5~VCC+0.5  VOUT -0.5~VCC+0.5  IIK ±20  IOK ±20  IOUT ±25  ICC ±25  PD 300 (FM8, SM8)  200 (US8)  Tstg -65~150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

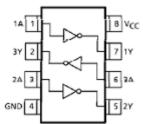
#### LOGIC DIAGRAM



#### TRUTH TABLE

А	Y
L	H
H.	L

# PIN ASSIGNMENT (TOP VIEW)



#### **OPERATING RANGE**

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	Vcc	2~6	١V
Input Voltage	VIN	0~Vcc	V
Output Voltage	VOUT	0~Vcc	V
Operating Temperature	Topr	- 40~85	°C



### DC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION			Ta = 25°C			$Ta = -40 \sim 85^{\circ}C$		UNIT
CHARACTERISTIC	3 TIVIBOL			Vcc	MIN.	TYP.	MAX.	MIN.	MAX.	ONIT
High-Level	VIH		_	2.0 4.5	1.7 3.6	_		1.7 3.6	_	<b>v</b>
Input Voltage				6.0	4.8	_	_	4.8	—	
Law Lovel				2.0	_	_	0.3	_	0.3	
Low-Level Input Voltage	V <sub>IL</sub>		_	4.5	—	_	0.9	_	0.9	v
input voitage				6.0	_	_	1.2	_	1.2	
		$V_{IN} = V_{IL}$ $V_{IN} = GND$		2.0	1.8	2.0	_	1.8	_	
High-Level	Voн		$I_{OH} = -20/tA$	4.5	4.0	4.5		4.0	—	
Output Voltage				6.0	5.5	5.9	_	5.5	_	V
Output voltage			$I_{OH} = -4mA$	4.5	4.18	4.31	-	4.13	—	
			V       -	$I_{OH} = -5.2 mA$	6.0	5.68	5.80	_	5. <b>6</b> 3	_
		V <sub>IN</sub> = V <sub>IH</sub>		2.0	—	0.0	0.2	_	0.2	
Low-Level			$I_{OL} = 20 \mu A$	4.5	—	0.0	0.5	_	0.5	
Output Voltage	VOL			6.0		0.1	0.5		0.5	V
Output voltage		V <sub>IN</sub> = V <sub>CC</sub>	$I_{OL} = 4mA$	4.5	—	0.17	0.26	_	0.33	
		VIN - VCC	$I_{OL} = 5.2 \text{mA}$	6.0		0.18	0.26	_	0.33	
Input Leakage Current	IN	VIN = VCC C	or GND	6.0	_	_	± 0.1	ı	± 1.0	
Quiescent Supply Current	lcc	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	1.0	_	10.0	μΑ

# AC ELECTRICAL CHARACTERISTICS ( $C_L = 15pF$ , $V_{CC} = 5V$ , Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	Т	UNIT		
CHARACTERISTIC	STIVIBOL	TEST CONDITION	MIN.	TYP.	MAX.	ONIT
Output Transition Time	t <sub>TLH</sub> t <sub>THL</sub>	_	_	4	8	ns
Propagation Delay Time	t <sub>pLH</sub> t <sub>pHL</sub>	_	_	4	8	ns

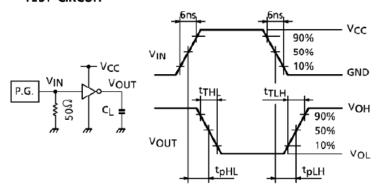
## AC ELECTRICAL CHARACTERISTICS ( $C_L = 50 \text{ pF}$ , Input $t_r = t_f = 6 \text{ ns}$ )

CHARACTERISTIC	SYMBOL	TEST CONDITION		T	a = 25°	Č.	Ta = -4	<b>10∼</b> 85°C	UNIT	
CHARACTERISTIC	3 TIVIBOL			MIN.	TYP.	MAX.	MIN.	MAX.	ONIT	
Output Transition	t		2.0	_	30	75	_	95		
Time	<sup>t</sup> TLH	_	4.5	—	8	15	—	19	ns	
Time	<sup>t</sup> THL		6.0	_	7	13	—	16		
Propagation Dalay	<b>4</b>		2.0	_	18	60	_	75		
Propagation Delay Time	Delay t <sub>pLH</sub>		_	4.5	—	6	12	—	15	ns
Time			6.0	—	5	10	—	13		
Input Capacitance	CIN	_		_	9	15	_	15		
Power Dissipation Capacitance	C <sub>PD</sub>	(Note 1)		_	13	_	_	_	pF	

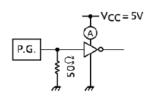
Note 1 : CpD is defined as the value of internal equivalent capacitance of IC which is calculated from the operating current consumption without load (refer to Test Circuit). Average operating current can be obtained by the equation hereunder.

ICC (opr) = CpD·VcC·flN + IcC/3 (per gate)

# SWITCHING CHARACTERISTICS TEST CIRCUIT



# OPERATING CURRENT CONSUMPTION TEST CIRCUIT

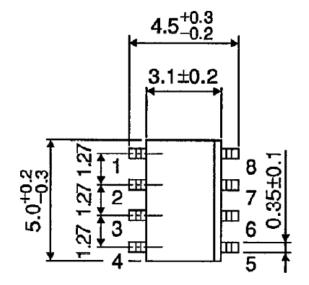


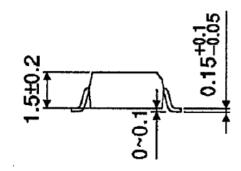
This input waveform is equal to SWITCHING CHARACTERISTICS TEST CIRCUIT input waveform.

# PACKAGE DIMENSIONS

SOP8-P-1.27

Unit: mm

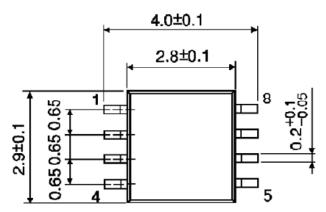


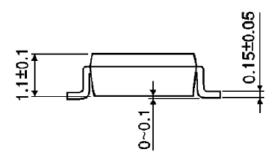


Weight: 0.05g (Typ.)

# PACKAGE DIMENSIONS

SSOP8-P-0.65 Unit: mm





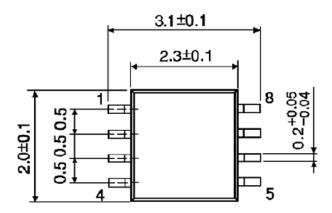
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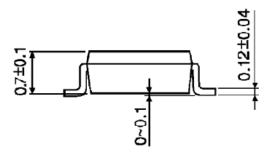
Weight: 0.02g (Typ.)

# PACKAGE DIMENSIONS

SSOP8-P-0.50A

Unit: mm





Weight: 0.01g (Typ.)

# **RESTRICTIONS ON PRODUCT USE**

20070701-EN GENERAL

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  in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such
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  - In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
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